

## PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT2826133

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JUNG AH LIM	04/03/2014
YONG-WON SONG	04/04/2014
JAE-MIN HONG	04/04/2014
WON-KOOK CHOI	04/03/2014
DAE SEONG EOM	04/04/2014
<b>RECEIVING PARTY DATA</b>	
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<b>Street Address:</b>	5, 14 GIL HWARANG-RO, SEONGBUK-GU
<b>City:</b>	SEOUL
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	136-791
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14259674
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(312)427-6663
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<b>Phone:</b>	3124271300
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<b>ATTORNEY DOCKET NUMBER:</b>	CU-71220 LKT/MC
<b>NAME OF SUBMITTER:</b>	LOREN K. THOMPSON
<b>SIGNATURE:</b>	/Loren K. Thompson/
<b>DATE SIGNED:</b>	04/23/2014
<b>Total Attachments: 4</b>	
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PATENT

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**UNITED STATES OF AMERICA**  
**ASSIGNMENT**

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In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

**ASSIGNOR:**

LIM, Jung Ah of Gyeonggi-do, KR  
 SONG, Yong-Won of Daejeon, KR  
 HONG, Jae-Min of Seoul, KR  
 CHOI, WON-KOOK of Seoul, KR  
 Eom, Dae Seong of Chungcheongbuk-do, KR

hereby sells, assigns and transfers to

**ASSIGNEE:**

KOREA INSTITUTE OF SCIENCE AND TECHNOLOGY of 5, 14 Gil Hwarang-ro,  
 Seongbuk-gu, Seoul 136-791, Republic of Korea

**ASSIGNEE NAME AND ADDRESS**

and the successors, assigns and legal representatives of the ASSIGNEE an undivided \_\_\_ percent (\_\_\_%) interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the Application entitled

**TITLE OF INVENTION:**

METHOD OF MANUFACTURING THIN FILM TRANSISTOR

and which is found in (37 CFR 3.21)

(a) Not yet filed U.S. patent application executed on even date herewith

(b) Not yet filed U.S. patent application executed on

\_\_\_\_\_ (insert date of execution of Declaration)

To comply with 37 CFR 3.21 for recordal of this assignment, I, an ASSIGNOR signing below, hereby authorize and request my attorney to insert below the filing date and application number when they become known.

- (c) U.S. patent or provisional patent application No. \_\_\_\_\_  
filed on \_\_\_\_\_
- (d) International application No. \_\_\_\_\_  
filed on \_\_\_\_\_

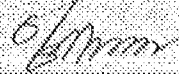
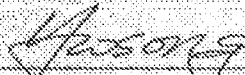
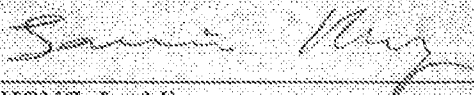
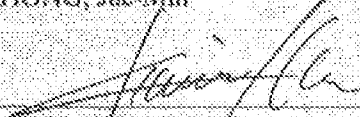
and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

*Note: The date of signing must be the same as the date of execution of the application if item (a) was checked above.*

<u>2014. 4. 3</u> Date	 LIM, Jung Ah
<u>2014. 4. 4</u> Date	 SONG, Yang-Won
<u>2014. 4. 4</u> Date	 HONG, Jas-Min
<u>2014. 4. 3</u> Date	 CHOI, WON-KOOK
_____ Date	_____ Eom, Dae Seong

L&P 08/2012 (Assignment - entire interest - US rights only)

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**UNITED STATES OF AMERICA**
**ASSIGNMENT**


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**ASSIGNEE NAME AND ADDRESS**

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(d) International application No. \_\_\_\_\_  
filed on \_\_\_\_\_

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof.

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IN WITNESS WHEREOF, I/we have set out hand and seal

*Note: The date of signing must be the same as the date of execution of the application if item (c) was checked above.*

\_\_\_\_\_  
Date

\_\_\_\_\_  
LIM, Jung Ah

\_\_\_\_\_  
Date

\_\_\_\_\_  
SONG, Yong-Won

\_\_\_\_\_  
Date

\_\_\_\_\_  
HONG, Jae-Min

\_\_\_\_\_  
Date

\_\_\_\_\_  
CHOI, WON-KOOK

\_\_\_\_\_  
April 4, 2014

\_\_\_\_\_  
Eom, Dae Seong

L&E 09/2012 (Assignment - entire business - US rights only)

*Dae Seong Eom*